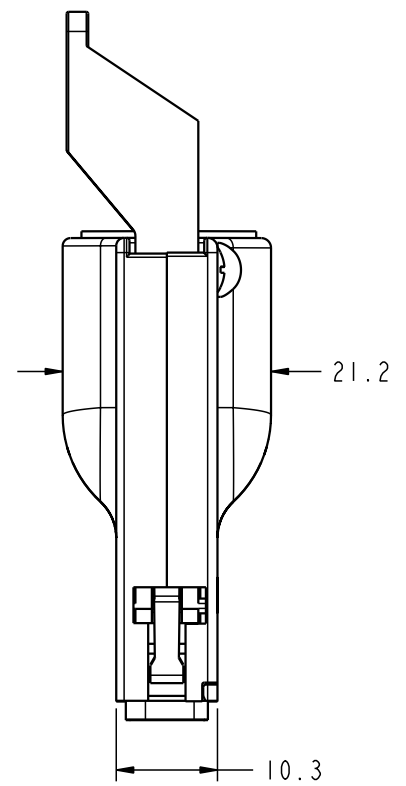
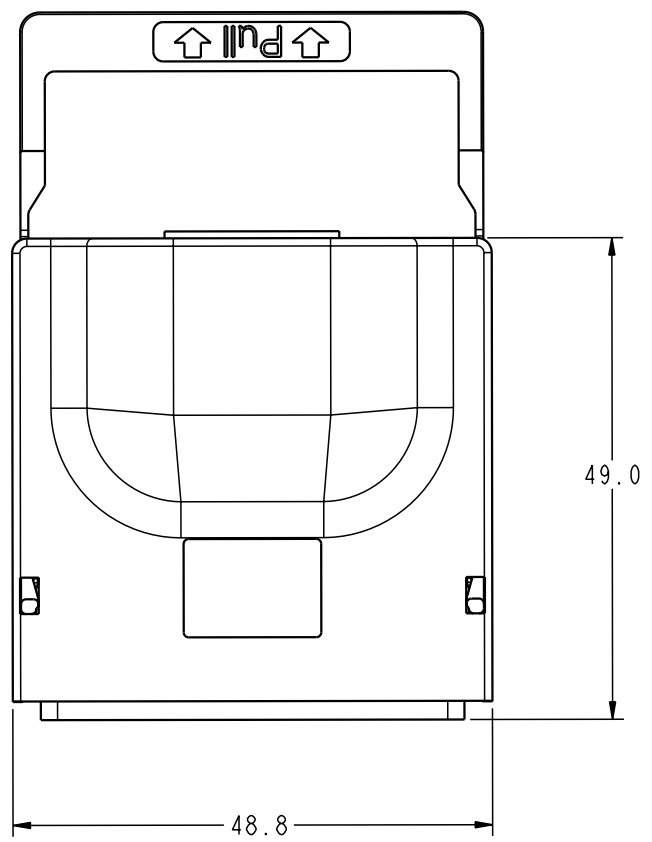




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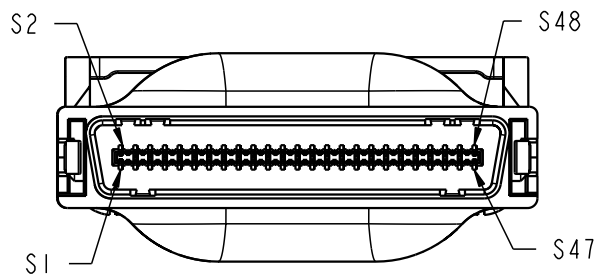
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PRODUCT NUMBER
10010264-001
10010264-001LF



NOTES:

- 1. MATES WITH FCI RECEPTACLES 58366 OR 58367.
- 2. MATERIALS:
 - BLOCKER - ALUMINUM ALLOY
 - BACKSHELL - ZINC ALLOY, NICKEL PLATING OVER COPPER
 - CONNECTOR - THERMOPLASTIC AND COPPER ALLOY
 - LATCH - THERMOPLASTIC AND STAINLESS STEEL
 - PRINTED CIRCUIT BOARD - FR4 FIBERGLASS
- 3. PRODUCT SPECIFICATION: GS-12-209.



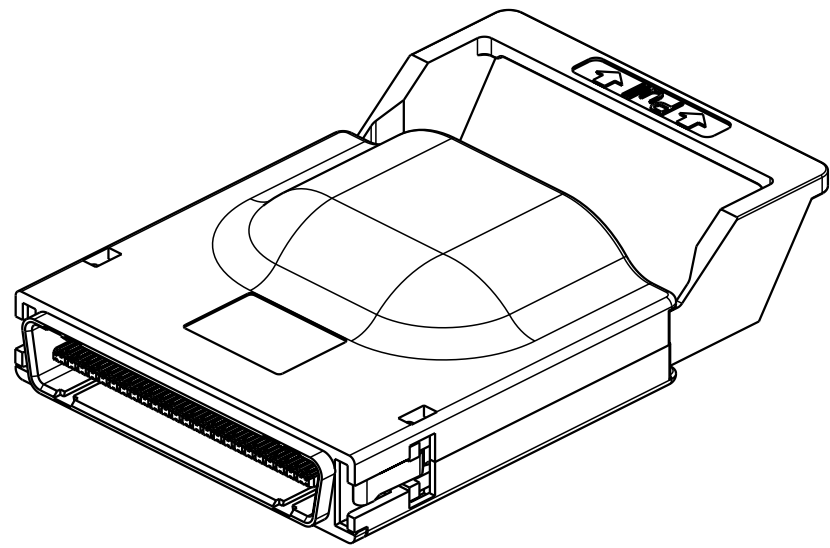
rev	ecn no	dr	date
A	CY21121	PC	07/09/02
B	CY21256	PC	11/22/02
C	CY31444	GL	06/17/03
D	V03-1234	DAI	12/05/03
E	V04-0483	DAI	06/17/04
F	V05-0064	TAB	03/07/05
G	V05-0542	TAB	06/17/05

TOLERANCES UNLESS OTHERWISE SPECIFIED			
LINEAR	0.X	±.3	
	0.XX	±.10	
	0.XXX	±.050	
ANGULAR	0°	±2°	

		www.fciconnect.com		surface ☒ ASME Y14.5	tolerance ASME Y14.5 -	projection	MM
Dr	PC	07/09/02	Product family	EYEMAX(tm)	size	A4	Scale 13:10
Eng	N.LEE	07/09/02	Spec ref		ECN	V05-0542	
Chr	PC	07/09/02	Material	SEE NOTES			
Appr	N.LEE	07/09/02					
title 12X EYEMAX LOOPBACK MODULE					dwg no 10010264	Rev. G	
catalog no -					CUSTOMER sheet 1 of 2		

PRODUCT NUMBER
10010264-001
10010264-001LF

PIN CONNECTIONS			
FROM		TO	
PIN NO.	SIGNAL	PIN NO.	SIGNAL
S1	IBtxIp(0)	S48	IBtxOp(0)
S2	IBtxIn(0)	S47	IBtxOn(0)
S3	IBtxIp(1)	S46	IBtxOp(1)
S4	IBtxIn(1)	S45	IBtxOn(1)
S5	IBtxIp(2)	S44	IBtxOp(2)
S6	IBtxIn(2)	S43	IBtxOn(2)
S7	IBtxIp(3)	S42	IBtxOp(3)
S8	IBtxIn(3)	S41	IBtxOn(3)
S9	IBtxIp(4)	S40	IBtxOp(4)
S10	IBtxIn(4)	S39	IBtxOn(4)
S11	IBtxIp(5)	S38	IBtxOp(5)
S12	IBtxIn(5)	S37	IBtxOn(5)
S13	IBtxIp(6)	S36	IBtxOp(6)
S14	IBtxIn(6)	S35	IBtxOn(6)
S15	IBtxIp(7)	S34	IBtxOp(7)
S16	IBtxIn(7)	S33	IBtxOn(7)
S17	IBtxIp(8)	S32	IBtxOp(8)
S18	IBtxIn(8)	S31	IBtxOn(8)
S19	IBtxIp(9)	S30	IBtxOp(9)
S20	IBtxIn(9)	S29	IBtxOn(9)
S21	IBtxIp(10)	S28	IBtxOp(10)
S22	IBtxIn(10)	S27	IBtxOn(10)
S23	IBtxIp(11)	S26	IBtxOp(11)
S24	IBtxIn(11)	S25	IBtxOn(11)



LEAD FREE NOTES:

1. LEAD FREE SOLDER TAIL PLATING 2μm(80μin) MIN MATTE TIN OVER 1.27μm(50μin) MIN NICKEL UNDERPLATE.
2. IF LEAD FREE PART NUMBER, THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 10 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.60mm MIN THICK CIRCUIT BOARD.
3. PACKAGING OF LEAD FREE PRODUCTS MEETS LABELING AND PACKAGING SPECIFICATION GS-14-920.
4. LEAD FREE PRODUCTS MEET EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008.

A FCI	title		dwg no	10010264	Rev. G
	12X EYEMAX LOOPBACK MODULE				
Pro/E file	catalog no	-	CUSTOMER	sheet 2 of 2	